

General Description

The MAX4740/MAX4740H low on-resistance (0.61 Ω typ) analog switches operate from a single 1.6V to 5.5V supply. The MAX4740/MAX4740H are quad, single-pole, double-throw (SPDT) switches and are configured to route audio signals. The MAX4740/MAX4740H are pin-to-pin compatible parts with the ST Microelectronics quad SPDT STG3699 analog switch.

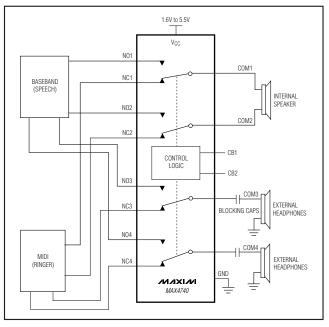
The MAX4740 is a quad SPDT switch and the MAX4740H is a quad SPDT switch that can be placed in a high-impedance mode. Switching logic is controlled by 2 control bits (CB1 and CB2). The MAX4740/MAX4740H also feature a low on-resistance match (0.06 Ω) and low power-supply current (0.3 μ A), which increases battery life.

The MAX4740/MAX4740H are available in a tiny 3mm x 3mm, 16-pin TQFN-EP, and 2.5mm x 2.5mm, 16-pin ultrathin QFN packages.

Applications

Voice Switching Cellular Phones PDAs and other Handheld Devices MP3 Player Notebook Computers

Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Features

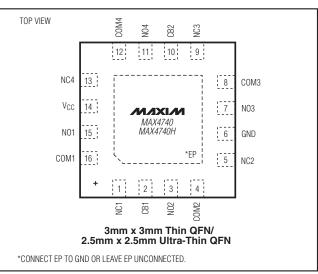
- Low On-Resistance (0.61Ω typ)
- ♦ 0.06Ω (typ) Channel-to-Channel Matching
- ♦ 0.32Ω (typ) On-Resistance Flatness
- ♦ 1.6V to 5.5V Single-Supply Voltage
- High PSRR Reduces Supply Noise (-60dB typ)
- 0.08% Total Harmonic Distortion
- -68dB typ Crosstalk (100kHz)
- -64dB typ Off-Isolation (100kHz)
- Low Supply Current (0.3µA typ)
- Low Leakage Current (0.1µA typ)
- ♦ Pin-to-Pin Compatible with ST Micro STG3699
- (3mm x 3mm) 16-Pin TQFN, and (2.5mm x 2.5mm) 16-Pin Ultra-Thin QFN Packages

Ordering Information

PART	PIN-PACKAGE	TOP MARK	PKG CODE
MAX4740ETE+	MAX4740ETE+ 16 TQFN-EP (3mm x 3mm)		T1633-4
MAX4740EVE+	16 Ultra-Thin QFN (2.5mm x 2.5mm)	+AAA	V162A2-1
MAX4740HETE+	16 TQFN-EP (3mm x 3mm)	AEW	T1633-4
MAX4740HEVE+	16 Ultra-Thin QFN (2.5mm x 2.5mm)	+AAB	V162A2-1

Note: All devices are guaranteed over the -40°C to +85°C temperature range. EP = Exposed pad.

Pin Configuration



Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.) V_{CC}, CB_....-0.3V to +6.0V

COM_, NC_, NO	0.3V to $(V_{CC} + 0.3V)$
Continuous Current NO_, NC_, COM	±300mA
Peak Current NO_, NC_, COM_	
(pulsed at 1ms, 50% duty cycle)	±400mA
Peak Current NO_, NC_, COM_	
(pulsed at 1ms, 10% duty cycle)	±500mA

Continuous Power Dissipation ($T_A = +70^{\circ}C$)
16-Pin TQFN (3mm x 3mm), Single-Layer Board
(derate 15.6mW/°C above +70°C)1250mW
16-Pin TQFN (3mm x 3mm), Multilayer Board (derate
20.8mW/°C above +70°C)1667mW
16-Pin Ultra-Thin QFN (2.5mm x 2.5mm), MultiLayer
Board (derate 11.5mW/°C above +70°C)923.8mW
Operating Temperature Range40°C to +85°C
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +2.7V \text{ to } +5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C, V_{CC} = +3.3V.)$ (Note 1)

PARAMETER	SYMBOL	CONDITIO	NS	MIN	ТҮР	MAX	UNITS	
POWER SUPPLY							1	
Supply Voltage Range	Vcc			1.6		5.5	V	
		$V_{CC} = +5.5V, V_{CB} = 0Vc$	$V_{CC} = +5.5V, V_{CB} = 0V \text{ or } V_{CC}$ $V_{CC} = +5.5V, V_{CB} = 0.5V \text{ or } +1.6V$		0.3	1		
Supply Current	Icc	$V_{CC} = +5.5V, V_{CB} = 0.5V$			0.3	5	μA	
		$V_{CC} = +2.5V, V_{CB} = 0.5V$	/ or +1.4V		0.1			
ANALOG SWITCH								
Analog Signal Range	V _{NC_} , V _{NO_} , V _{COM_} ,	(Note 2)		0		V _{CC}	V	
		$V_{CC} = 3.3V, I_{COM} =$	$T_A = +25^{\circ}C$		0.61	0.90		
On-Resistance	R _{ON}	100mA; CB_ = low or high	$T_A = T_{MIN}$ to T_{MAX}			1	Ω	
		$V_{CC} = 3.3V$, V_{NC} or	$T_A = +25^{\circ}C$		0.06	0.1		
On-Resistance Match Between Channels	ΔR_{ON}	V _{NO} = 0.875V; I _{COM} = 100mA (Note 3)	$T_A = T_{MIN}$ to T_{MAX}				Ω	
		$V_{CC} = 3.3V, V_{COM} = 0$	$T_A = +25^{\circ}C$		0.32	0.72		
On-Resistance Flatness	R _{FLAT(NO)}	to V _{CC} ; I _{COM} = 100mA (Note 4)	$T_A = T_{MIN}$ to T_{MAX}			0.87	Ω	
NO_, NC_ Off-Leakage Current	I _{NO_} (OFF), I _{NC_} (OFF)	$V_{CC} = 5.5V; V_{NC}$ or $V_{NO} = 0.3V, 5.5V; V_{COM} = 5.5V$ or 0.3V		-1	0.1	+1	μA	
COM_ On-Leakage Current	ICOM_(ON)	V_{CC} = 5.5V, V_{NC-} or V_{NO-} = 0.3V, 5.5V, or unconnected; V_{COM-} = 0.3V, 5.5V, or unconnected		-1	0.1	+1	μA	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +2.7V \text{ to } +5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C, V_{CC} = 3.3V.)$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
DYNAMIC CHARACTERISTICS								
	tau	$R_L = 32\Omega, C_L =$	For NO_, V_{NO} = 1V		70			
Turn-On Time	ton	35pF, Figure 2	For NC_, $V_{NC} = 1V$		210		ns	
Turn-Off Time	t	$R_L = 32\Omega, C_L =$	For NO_, V _{NO} _ = 1V		210			
	tOFF	35pF, Figure 2	For NC_, V_{NC} = 1V		55		ns	
Charge Injection	Q	V _{GEN} = 0V; R _{GEN} = Figure 3	= 0 Ω ; C _L = 1nF;		200		рС	
Off-Isolation	VISO	$C_L = 5pF; R_L = 32\Omega; f = 100kHz;$ $V_{COM_} = 1V_{RMS};$ Figure 4 (Note 5)			-64		dB	
Crosstalk	V _{CT}	$C_L = 5pF; R_L = 32\Omega; f = 100kHz;$ $V_{COM_} = 1V_{RMS}; Figure 4$			-68		dB	
Power-Supply Rejection Ratio	PSRR	$ \begin{array}{l} f=20 \text{kHz}, \ \text{V}_{COM_}=1 \text{V}_{RMS}, \ \text{R}_{L}=50 \Omega, \\ \text{C}_{L}=5 \text{pF} \end{array} $			-60		dB	
Total Harmonic Distortion	THD	f = 20Hz to $20kHz$, V	$V_{P-P} = 0.5V, R_L = 32\Omega$		0.08		%	
NO_, NC_ Off-Capacitance	C _{NC_(OFF)} , C _{NO_(OFF)}	f = 1MHz, Figure 5			40		pF	
COM_ On-Capacitance	C _{COM} (ON)	f = 1MHz, Figure 5			150		pF	
DIGITAL INPUTS (CB_)								
Input Logic-High	Viii i	$V_{CC} = 1.6V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 5.5V$		1.4			V	
	VIH			1.6				
Input Logic-Low	VIL					0.5	V	
Input Leakage Current	lin			-1	0.1	+1	μΑ	

Note 1: For TQFN (3mm x 3mm) electrical specifications are production tested at $T_A = +85^{\circ}$ C and guaranteed by design at $T_A = +25^{\circ}$ C and -40°C. For Ultra-Thin QFN (2.5mm x 2.5mm) electrical specifications are production tested at $T_A = +25^{\circ}$ C and guaranteed by design at $T_A = +85^{\circ}$ C and -40°C.

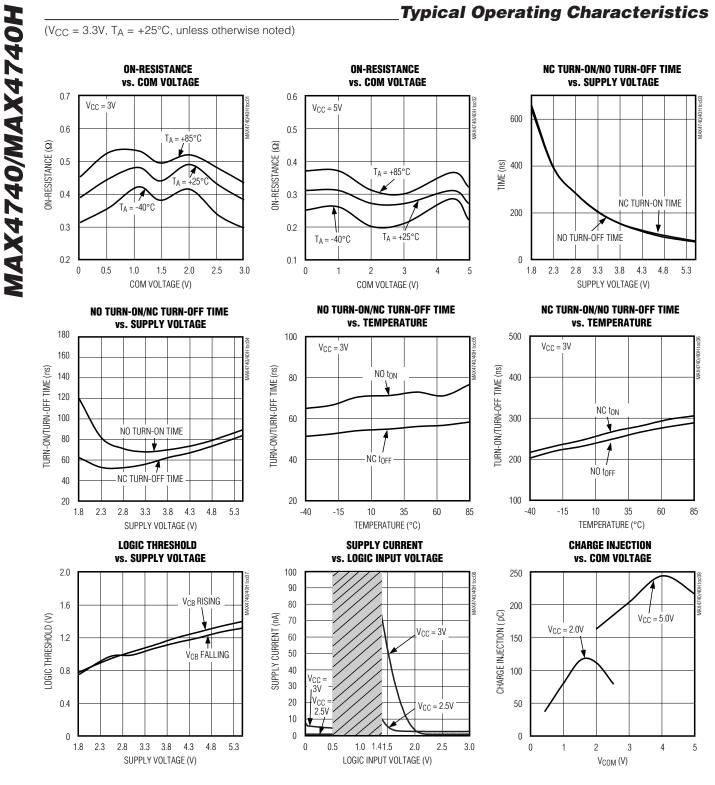
Note 2: Signals on COM_, NO_, or NC_ exceeding V_{CC} are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Note 3: $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$.

Note 4: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Note 5: Off-isolation = $20\log_{10} [V_{COM} / V_{NO}], V_{COM}$ = output, V_{NO} = input to off switch.

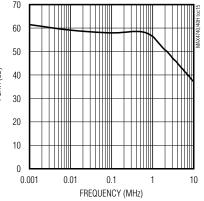
4



Typical Operating Characteristics (continued) LEAKAGE CURRENT FREQUENCY RESPONSE vs. TEMPERATURE 0 100,000 10,000 4 -2 ICOM(OFF) (BN-LOSS (dB) ICOM(ON) -4 1 -6 0.1 0.01 100 0.1 1 10 -40 -15 10 35 60 85 FREQUENCY (MHz) TEMPERATURE (°C) **OFF-ISOLATION vs. FREQUENCY CROSSTALK vs. FREQUENCY** 0 0 -20 -20 OFF-ISOLATION (dB) CROSSTALK (dB) -40 -40 -60 -60 -80 -80 0.01 0.1 0.001 10 1 0.001 0.01 0.1 1 10 FREQUENCY (MHz) FREQUENCY (MHz) **TOTAL HARMONIC DISTORTION POWER-SUPPLY REJECTION** vs. FREQUENCY **RATIO vs. FREQUENCY** 70 1 $R_L = 32\Omega$ 60 50 PSRR (dB) THD (%) 40 0.1 30 20 10 0.01 0 10 100 1k 100k 0.001 0.01 0.1 10 10k 1 FREQUENCY (Hz) FREQUENCY (MHz)

 $(V_{CC} = 3.3V, T_A = +25^{\circ}C, unless otherwise noted)$





MAX4740/MAX4740H

_____Pin Description

PIN	NAME	FUNCTION
1	NC1	Analog Switch 1—Normally Closed Terminal
2	CB1	Digital Control Input for Analog Switch 1 and Analog Switch 2
3	NO2	Analog Switch 2—Normally Open Terminal
4	COM2	Analog Switch 2—Common Terminal
5	NC2	Analog Switch 2—Normally Closed Terminal
6	GND	Ground
7	NO3	Analog Switch 3—Normally Open Terminal
8	COM3	Analog Switch 3—Common Terminal
9	NC3	Analog Switch 3—Normally Closed Terminal
10	CB2	Digital Control Input for Analog Switch 3 and Analog Switch 4
11	NO4	Analog Switch 4—Normally Open Terminal
12	COM4	Analog Switch 4—Common Terminal
13	NC4	Analog Switch 4—Normally Closed Terminal
14	Vcc	Positive Supply Voltage
15	NO1	Analog Switch 1—Normally Open Terminal
16	COM1	Analog Switch 1—Common Terminal
EP	EP	Exposed Pad. Connect to GND or leave unconnected for normal operation.

Detailed Description

The MAX4740/MAX4740H quad SPDT audio switches are low on-resistance, low supply current, high powersupply rejection ratio (PSRR) devices that operate from a +1.6V to +5.5V single supply. The MAX4740/ MAX4740H have two digital control inputs, CB1 and CB2, where each bit controls a pair of switches (see Tables 1 and 2).

Applications Information

The MAX4740/MAX4740H logic inputs accept up to +5.5V, regardless of supply voltage. For example with a +3.3V supply, CB1 and CB2 can be driven low to GND and high to +5.5V, allowing for mixed logic levels in a system. Driving CB1 and CB2 rail-to-rail minimizes power consumption. For a 3.3V supply voltage, the logic thresholds are +0.5V (low) and +1.6V (high).

Analog Signal Levels

Analog signals that range over the entire supply voltage range (V_{CC} to GND) can be passed with very little change in on-resistance (see the *Typical Operating Characteristics*). The switches are bidirectional, so the NO_, NC_, and COM_ terminals can be used as either inputs or outputs.

Table 1. MAX4740 Truth Table

CONTROL		SWIT	CH STATE
CB2	CB1	Switch 3/4	Switch 1/2
0	0	COM = NC	COM = NC
0	1	COM = NC	COM = NO
1	0	COM = NO	COM = NC
1	1	COM = NO	COM = NO

Table 2. MAX4740H Truth Table

CONTROL		SWIT	CH STATE
CB2	CB1	Switch 3/4	Switch 1/2
0	0	COM = NC	COM = NC
0	1	High-Z	High-Z
1	0	COM = NO	COM = NC
1	1	COM = NO	COM = NO

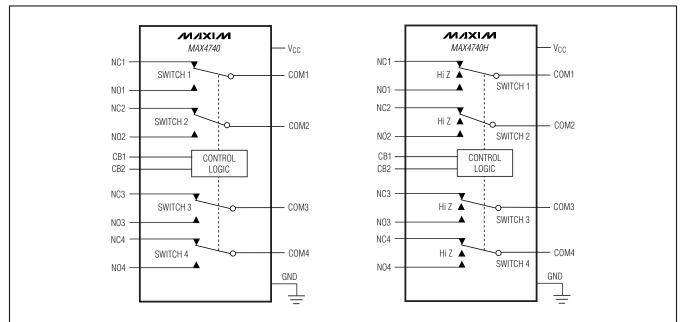


Figure 1. Functional Diagram

_Test Circuits/Timing Diagrams

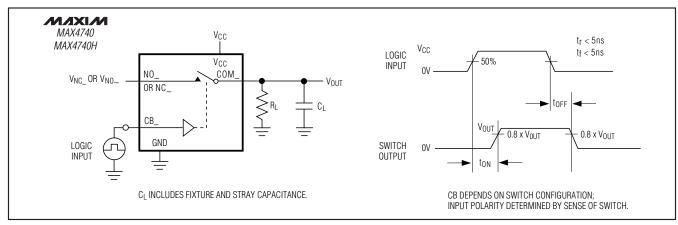


Figure 2. Switching Time

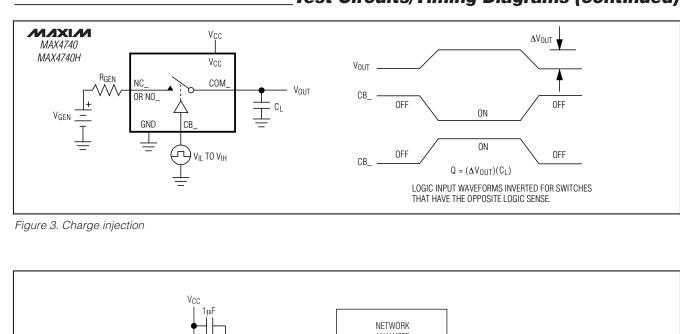
Power-Supply Sequencing and Overvoltage Protection

Caution: Do not exceed the Absolute Maximum Ratings since stresses beyond the listed ratings may cause permanent damage to the device.

Proper power-supply sequencing is recommended for all CMOS devices. Improper supply sequencing can force the switch into latch-up, causing it to draw excessive supply current. The only way out of latch-up is to recycle the power and reapply properly. Connect all ground pins first, then apply power to V_{CC} , and finally apply signals to NO_, NC_, and COM_. Follow the reverse order upon power-down.

Chip Information

PROCESS: BICMOS



Test Circuits/Timing Diagrams (continued)

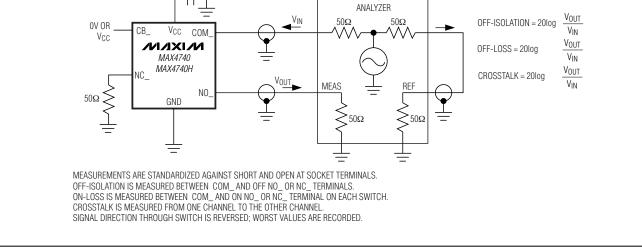


Figure 4. Off-Isolation, On-Loss, and Crosstalk

MAX4740/MAX4740H

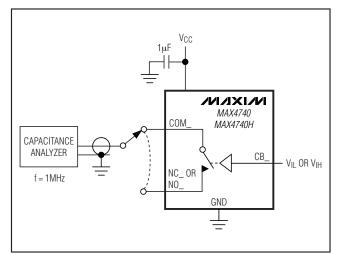
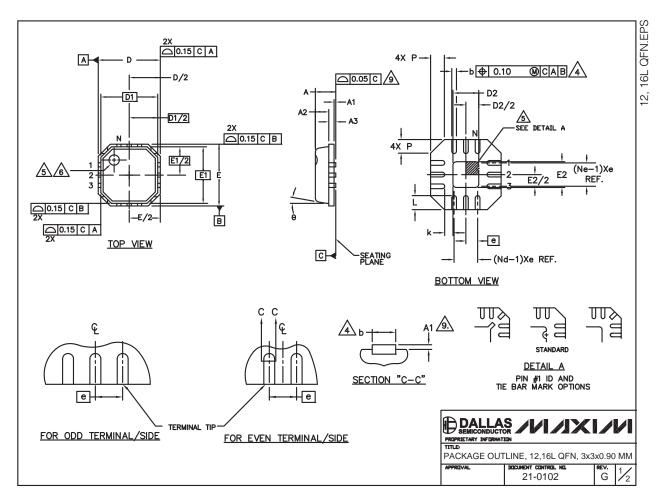


Figure 5. Channel Off/On-Capacitance

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS						
PKG		12L 3x3			16L 3x3	
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.80	0.90	1.00	0.80	0.90	1.00
A1	0.00	0.01	0.05	0.00	0.01	0.05
A2	0.00	0.65	1.00	0.00	0.65	1.00
A3		0.20 REF			0.20 REF	-
b	0.18	0.23	0.30	0.18	0.23	0.30
D	2.90	3.00	3.10	2.90	3.00	3.10
D1		2.75 BS(C	2.75 BSC		
E	2.90	3.00	3.10	2.90	3.00	3.10
E1		2.75 BS	0	2.75 BSC		
е	0.50 BSC				0.50 BSC	;
k	0.25	-	-	0.25	-	-
L	0.35	0.55	0.75	0.30	0.40	0.50
N	12				16	
ND	3				4	
NE		3		4		
Р	0.00	0.42	0.60	0.00	0.42	0.60
θ	0°		12*	0*		12*

EXPOSED PAD VARIATIONS						
PKG.		D2			E2	
CIDES	MIN.	NDM.	MAX.	MIN.	N⊡M.	MAX.
G1233-1	0.95	1.10	1.25	0.95	1.10	1.25
G1633-2	0.95	1.10	1.25	0.95	1.10	1.25

NOTES:

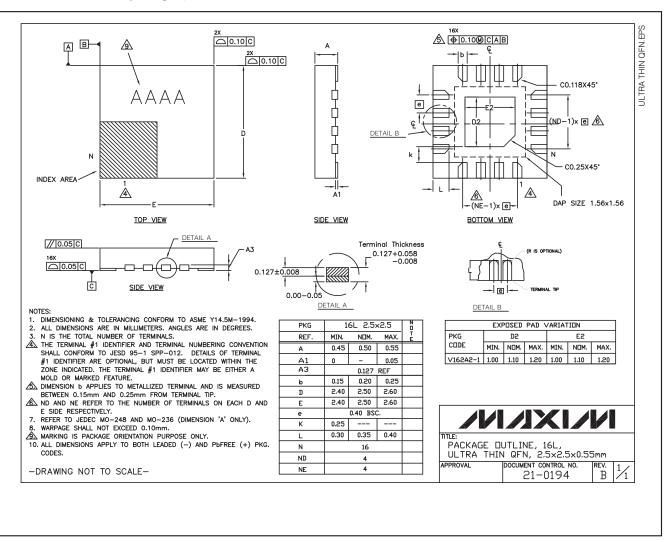
- 1. DIE THICKNESS ALLOWABLE IS 0.305mm MAXIMUM (.012 INCHES MAXIMUM).
- 2. DIMENSIONING & TOLERANCES CONFORM TO ASME Y14.5M. 1994.
- AN IS THE NUMBER OF TERMINALS. No IS THE NUMBER OF TERMINALS IN X-DIRECTION & No IS THE NUMBER OF TERMINALS IN Y-DIRECTION.
- A DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25mm FROM TERMINAL TIP.
- THE PIN #1 IDENTIFIER MUST EXIST ON THE TOP SURFACE OF THE PACKAGE BY USING INDENTATION MARK OR INK/LASER MARKED. DETAILS OF PIN #1 IDENTIFIER IS OPTIONAL, BUT MUST BE LOCATED WITHIN ZONE INDICATED.
- 6 EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.
- 7. ALL DIMENSIONS ARE IN MILLIMETERS.
- 8. PACKAGE WARPAGE MAX 0.05mm.
- APPLIED FOR EXPOSED PAD AND TERMINALS. EXCLUDE EMBEDDING PART OF EXPOSED PAD FROM MEASURING. 10. MEETS JEDEC MO220.
- 11. THIS PACKAGE OUTLINE APPLIES TO ANVIL SINGULATION (STEPPED SIDES).

IND DALLAG	
SEMICONDUCTOR	
PROPRIETARY INFORMATION	
TITLE	

	LINE, 12,16L QFN, 3x3		
APPREVAL	21-0102	rev. G	$\frac{1}{2}$

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <u>www.maxim-ic.com/packages</u>.)



Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	5/06	Initial release	—
1	11/07	Adding ultra-thin QFN package	1, 2, 3, 10–13

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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